



1200V SiC ED3 Power Module

ADPR30B12CSNT

**PRELIMINARY
DATASHEET**

V0.1, 2023/12



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ADPR30B12CSNT Power Module



Applications

- Automotive Applications
- Electrical Vehicles (xEV)
- Commercial Agriculture Vehicles
- All-Terrain Vehicles
- Motor Drives
- Servo Drives
- UPS Drives

Electrical Features

- Low $R_{DS(on)}$
- $T_{j,op} = 150^\circ\text{C}$
- Blocking voltage 1200V
- Low Switching Losses
- Low Inductive Design
- SiC High Performance Chip

Mechanical Features

- Compact design
- UL 94 Module frame
- Temperature sensor included
- Pb-free device and RoHS compliant
- Guiding elements for PCB and cooler assembly
- Sintered Ag Die attachment



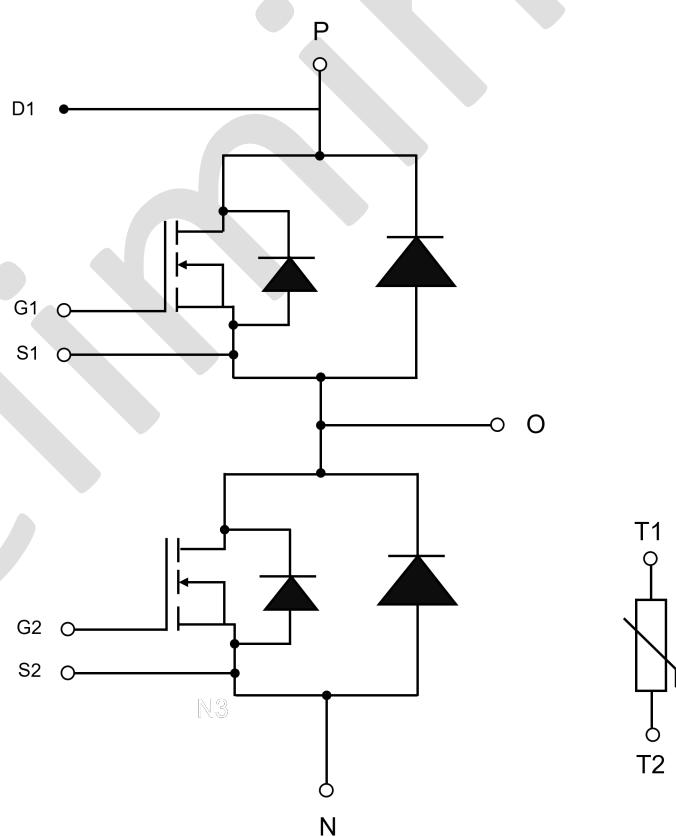
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FEATURES

- High speed, low loss SiC module
- High reliability, high durability module

Inner Circuit Diagram





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MOSEFT

Maximum Rated Values

Parameter	Conditions	Symbol	Values	Unit
Drain-source voltage	$T_j = 25^\circ\text{C}$	V_{DSS}	1200	V
Gate-source voltage		V_{GS}	-5/+20	V
DC drain current	$V_{GS} = 15 \text{ V}, T_c = 70^\circ\text{C}, T_j = 175^\circ\text{C}$	$I_{D \text{ nom}}$	600	A
Pulsed drain current	Verified by design, t_p limited by $T_{j, \text{max}}$	$I_{D \text{ pulse}}$	1200	A

Characteristics Values

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Drain-source on resistance	$I_D = 600 \text{ A}, V_{GS} = 15 \text{ V}$	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$ $T_j = 175^\circ\text{C}$	$R_{DS(on)}$	3.0 4.5 5.4	5.9	$\text{m}\Omega$
	$I_D = 600 \text{ A}, V_{GS} = 15 \text{ V}$					
	$I_D = 600 \text{ A}, V_{GS} = 15 \text{ V}$					
Gate threshold voltage	$I_D = 175 \text{ mA}, V_{GS} = V_{DS}$	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$ $T_j = 175^\circ\text{C}$	V_{Gsth}	2.2 2.7 2.6	3.2 4.2	V
	$I_D = 175 \text{ mA}, V_{GS} = V_{DS}$					
	$I_D = 175 \text{ mA}, V_{GS} = V_{DS}$					
Drain-source leakage current	$V_{DS} = 1200 \text{ V}, V_{GS} = 0 \text{ V}$	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$ $T_j = 175^\circ\text{C}$	I_{DSS}	1 5	100	μA
	$V_{DS} = 1200 \text{ V}, V_{GS} = 0 \text{ V}$					
	$V_{DS} = 1200 \text{ V}, V_{GS} = 0 \text{ V}$					
Gate-source leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$	$T_j = 25^\circ\text{C}$	I_{GSS}		400	nA
Input capacitance	$f = 100 \text{ kHz}, V_{DS} = 100 \text{ V}$ $V_{GS} = 0 \text{ V}$	$T_j = 25^\circ\text{C}$	C_{iss}	37		nF
Output capacitance	$f = 100 \text{ kHz}, V_{DS} = 100 \text{ V}$ $V_{GS} = 0 \text{ V}$	$T_j = 25^\circ\text{C}$	C_{oss}		7.9	nF
Reverse transfer capacitance	$f = 100 \text{ kHz}, V_{DS} = 100 \text{ V}$ $V_{GS} = 0 \text{ V}$	$T_j = 25^\circ\text{C}$	C_{rss}		0.03	nF
Turn-on delay time, inductive load	$I_D = 600 \text{ A}, V_{DS} = 600 \text{ V}$ $V_{GS} = -5 \text{ V} / +15 \text{ V}$ $R_G = 5.0 \Omega$	$T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$	$t_{d(on)}$		49 27	ns
Rise time, inductive load	$I_D = 600 \text{ A}, V_{DS} = 600 \text{ V}$ $V_{GS} = -5 \text{ V} / +15 \text{ V}$ $R_G = 5.0 \Omega$	$T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$	t_r		116 85	ns



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Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Turn-on energy loss per pulse	$I_D = 600 \text{ A}$, $V_{DS} = 600 \text{ V}$ $L_S = 30\text{nH}$ $V_{GS} = -5 \text{ V} / + 15 \text{ V}$ $R_G = 5.0 \Omega$, $dI/dt = 4250 \text{ A}/\mu\text{s}$ (25°C) $dI/dt = 6000 \text{ A}/\mu\text{s}$ (175°C)	$T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$	E_{on}		27.5 20.5	mJ
Turn-off delay time, inductive load	$I_D = 600 \text{ A}$, $V_{DS} = 600 \text{ V}$ $V_{GS} = -5 \text{ V} / + 15 \text{ V}$ $R_G = 5.0 \Omega$	$T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$	$t_{d(off)}$		235 275	ns
Fall time, inductive load	$I_D = 600 \text{ A}$, $V_{DS} = 600 \text{ V}$ $V_{GS} = -5 \text{ V} / + 15 \text{ V}$ $R_G = 5.0 \Omega$	$T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$	t_f		76 77	ns
Turn-off energy loss per pulse	$I_D = 600 \text{ A}$, $V_{DS} = 600 \text{ V}$ $L_S = 30\text{nH}$ $V_{GS} = -5 \text{ V} / + 15 \text{ V}$ $R_G = 5.0 \Omega$, $dV/dt = 11.5 \text{ kV}/\mu\text{s}$ (25°C) $dV/dt = 12.0 \text{ kV}/\mu\text{s}$ (175°C)	$T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$	E_{off}		15.5 16.0	mJ
Thermal resistance, junction to case	Per MOSFET; $\Delta V/\Delta T = 10 \text{ dm}^3/\text{min}$, $T_F = 60^\circ\text{C}$		R_{thJC}		0.095	K/W
Thermal resistance, junction to case	Per Diode; $\Delta V/\Delta T = 10 \text{ dm}^3/\text{min}$, $T_F = 60^\circ\text{C}$		R_{thJC}		0.07	K/W



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Diode

Maximum Rated Values

Parameter	Conditions	Symbol	Values	Unit
DC body diode forward current	$V_{GS} = -5 \text{ V}$, $T_j = 175^\circ\text{C}$	I_{SD}	600	A
Pulsed body diode current	Verified by design, t_p limited by $T_{j, \text{max}}$	$I_{SD, \text{pulse}}$	1200	A

Characteristics Values

Parameter	Conditions	Symbol	Typ.	Max.	Unit
Forward voltage	$I_{SD} = 600 \text{ A}$, $V_{GS} = -5 \text{ V}$	V_{SD}	1.9	2.5	V
Peak reverse recovery current	$I_F = 600 \text{ A}$, $V_R = 600 \text{ V}$, $V_{GE} = -5 \text{ V}$, $-di_F/dt = 5700 \text{ A}/\mu\text{s}$ (25°C) $-di_F/dt = 6400 \text{ A}/\mu\text{s}$ (150°C)	I_{RM}	115 140		A
Recovered charge	$I_F = 600 \text{ A}$, $V_R = 600 \text{ V}$, $V_{GE} = -5 \text{ V}$, $-di_F/dt = 5700 \text{ A}/\mu\text{s}$ (25°C) $-di_F/dt = 6400 \text{ A}/\mu\text{s}$ (150°C)	Q_{rr}	3.5 4.3		μC
Reverse recovery energy	$I_F = 600 \text{ A}$, $V_R = 600 \text{ V}$, $V_{GE} = -5 \text{ V}$, $-di_F/dt = 5700 \text{ A}/\mu\text{s}$ (25°C) $-di_F/dt = 6400 \text{ A}/\mu\text{s}$ (150°C)	E_{rec}	0.45 0.68		mJ

NTC-Thermistor

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Rated resistance	$T_c = 25^\circ\text{C}$	R_{25}		5.0		k Ω
Resistance tolerance	$T_c = 100^\circ\text{C}$	$\Delta R/R$	5		5	%
B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$	$B_{25/50}$		3375		K
B-value	$R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298.15 \text{ K}))]$	$B_{25/80}$		3411		K
B-value	$R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298.15 \text{ K}))]$	$B_{25/100}$		3433		K



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Module

Parameter	Conditions	Symbol	Value	Unit
Module baseplate material			Cu + Ni	
Module internal isolation material			Si_3N_4	
Comparative tracking index ¹⁾		CTI	200	

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Module stray inductance		L_s		18		nH
Storage temperature		T_{stg}	-40		125	°C
Weight		G		350		g

1) Extracted by following UL 746A

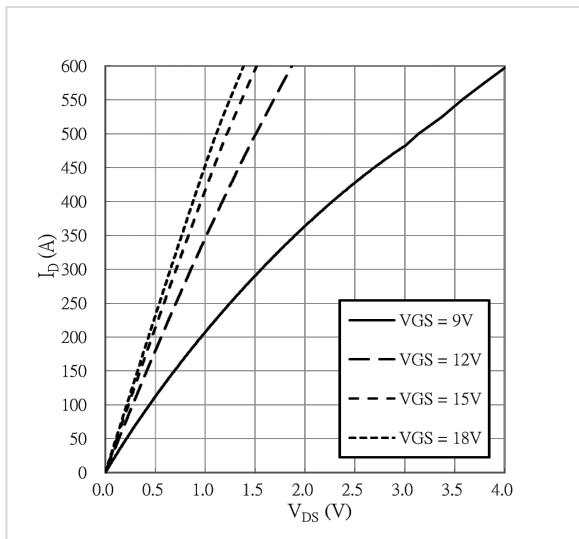


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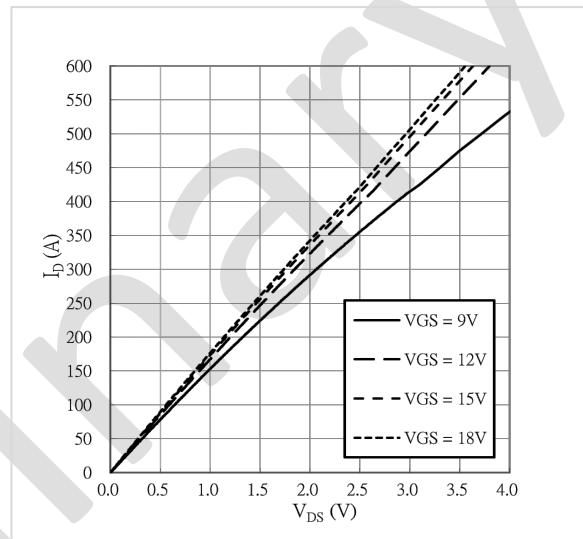
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Characteristics Diagrams

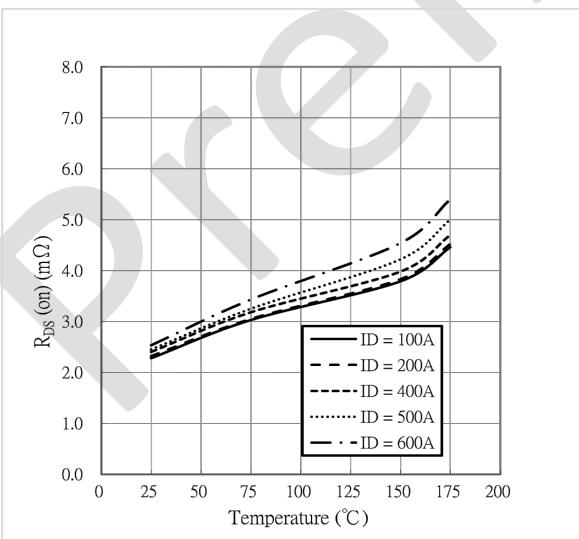
Output Characteristics MOSFET, Inverter
 $T_j = 25^\circ\text{C}$, $I_D = f(V_{DS})$



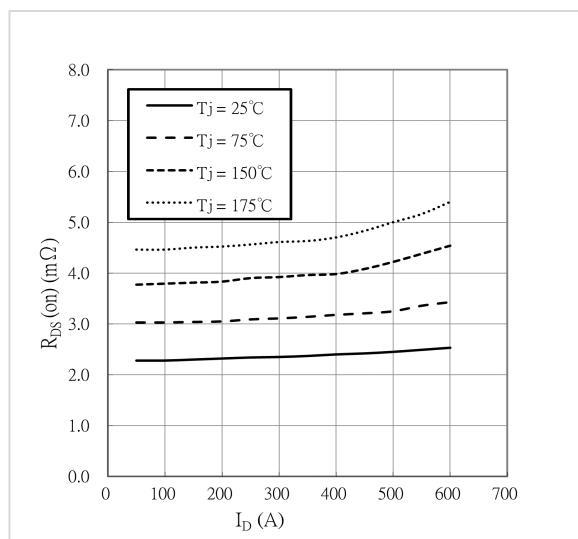
Output Characteristics MOSFET, Inverter
 $T_j = 175^\circ\text{C}$, $I_D = f(V_{DS})$



Typical temperature dependence of $R_{DS(on)}$,
 $V_{GS} = 15\text{V}$, $I_D = 600\text{A}$, $R_{DS(on)} = f(T_j)$



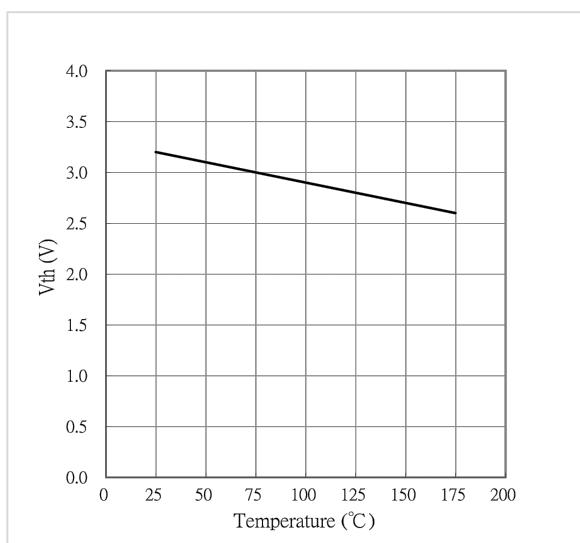
Typical ID dependence of $R_{DS(on)}$,
 $V_{GS} = 15\text{V}$, $R_{DS(on)} = f(I_D)$



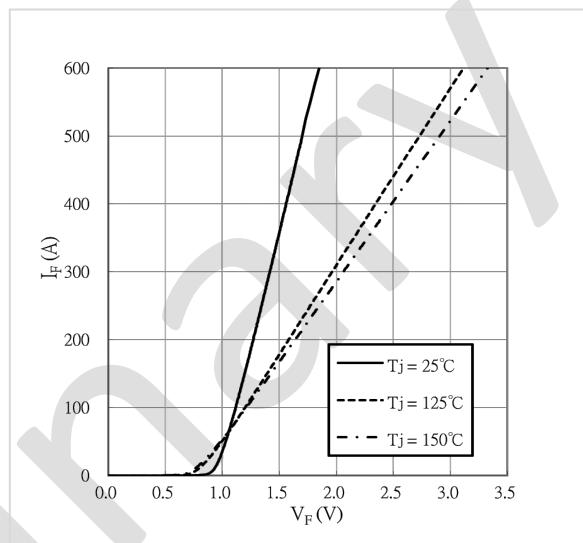
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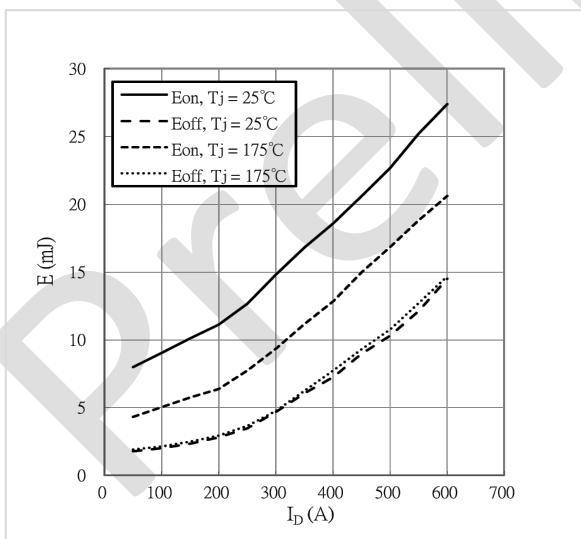
Typical temperature dependence of threshold voltage, $V_{th} = f(T_j)$



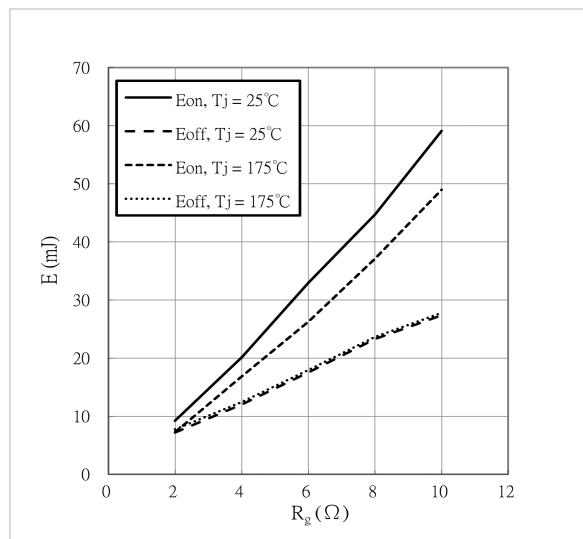
Forward characteristics of Diode, Inverter
 $V_{GS} = -5V$, $I_F = f(V_F)$



Switching loss MOSFET, Inverter
 $V_{GS} = -5V/+15V$, $R_{GON} = 5.0\Omega$, $R_{Goff} = 5.0\Omega$,
 $V_{DS} = 600V$, E_{on} & $E_{off} = f(I_D)$



Switching loss MOSFET, Inverter
 $V_{GS} = -5V/+15V$, $V_{DS} = 600V$, $I_D = 600A$,
 E_{on} & $E_{off} = f(R_g)$

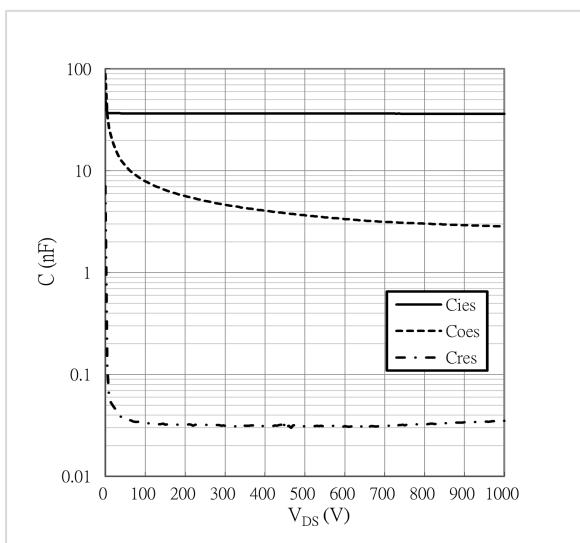




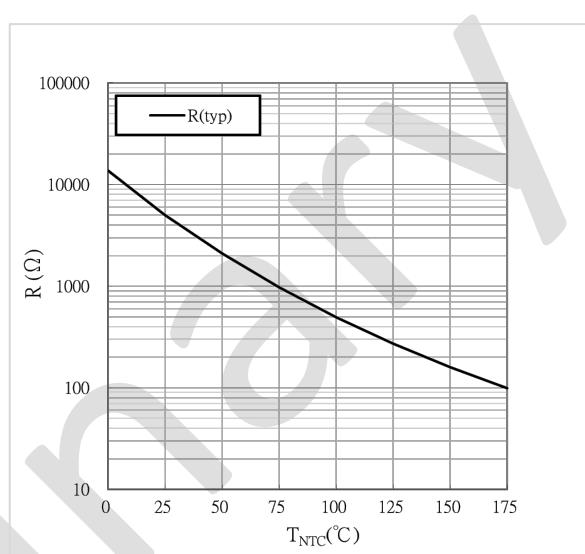
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Capacitance characteristics MOSFET, inverter
 $V_{GS} = 0V$, $T_j = 25^\circ C$, $f = 100\text{KHz}$, $C = f(V_{DS})$

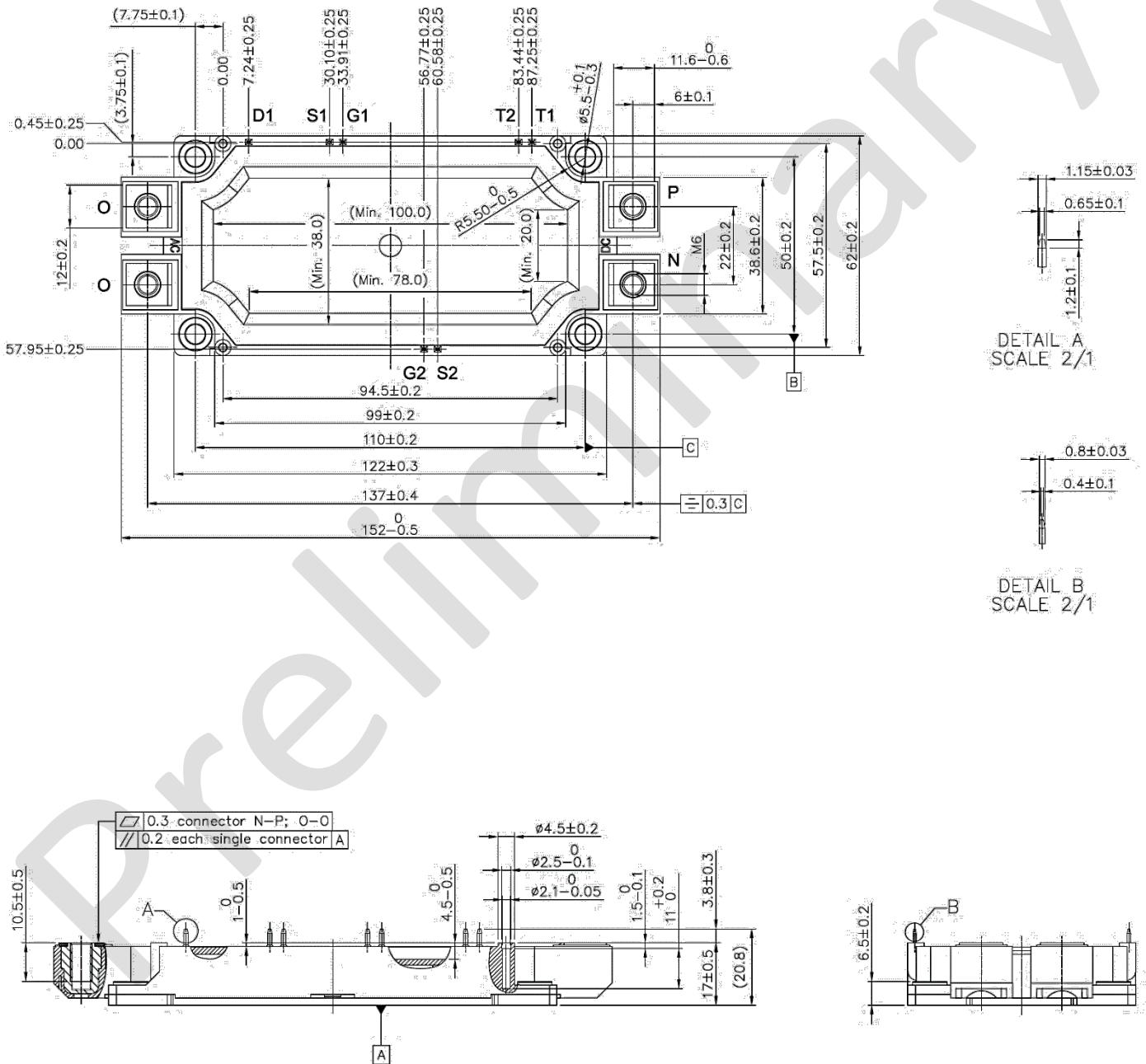


NTC-Thermistor-temperature characteristics





Package Outlines



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